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### What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

### Applications of "[Embedded - Microcontrollers](#)"

#### Details

Product Status	Obsolete
Core Processor	PIC
Core Size	8-Bit
Speed	4MHz
Connectivity	-
Peripherals	Brown-out Detect/Reset, POR, WDT
Number of I/O	13
Program Memory Size	3.5KB (2K x 14)
Program Memory Type	OTP
EEPROM Size	-
RAM Size	128 x 8
Voltage - Supply (Vcc/Vdd)	2.5V ~ 6V
Data Converters	-
Oscillator Type	External
Operating Temperature	-40°C ~ 125°C (TA)
Mounting Type	Surface Mount
Package / Case	20-SSOP (0.209", 5.30mm Width)
Supplier Device Package	20-SSOP
Purchase URL	<a href="https://www.e-xfl.com/product-detail/microchip-technology/pic16lc622-04e-ss">https://www.e-xfl.com/product-detail/microchip-technology/pic16lc622-04e-ss</a>

# PIC16C62X

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## Device Differences

Device	Voltage Range	Oscillator	Process Technology (Microns)
PIC16C620 <sup>(3)</sup>	2.5 - 6.0	See <b>Note 1</b>	0.9
PIC16C621 <sup>(3)</sup>	2.5 - 6.0	See <b>Note 1</b>	0.9
PIC16C622 <sup>(3)</sup>	2.5 - 6.0	See <b>Note 1</b>	0.9
PIC16C620A <sup>(4)</sup>	2.7 - 5.5	See <b>Note 1</b>	0.7
PIC16CR620A <sup>(2)</sup>	2.5 - 5.5	See <b>Note 1</b>	0.7
PIC16C621A <sup>(4)</sup>	2.7 - 5.5	See <b>Note 1</b>	0.7
PIC16C622A <sup>(4)</sup>	2.7 - 5.5	See <b>Note 1</b>	0.7

**Note 1:** If you change from this device to another device, please verify oscillator characteristics in your application.

**2:** For ROM parts, operation from 2.5V - 3.0V will require the PIC16LCR62X parts.

**3:** For OTP parts, operation from 2.5V - 3.0V will require the PIC16LC62X parts.

**4:** For OTP parts, operations from 2.7V - 3.0V will require the PIC16LC62XA parts.

# PIC16C62X

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NOTES:

**TABLE 3-1: PIC16C62X PINOUT DESCRIPTION**

Name	DIP/SOIC Pin #	SSOP Pin #	I/O/P Type	Buffer Type	Description
OSC1/CLKIN	16	18	I	ST/CMOS	Oscillator crystal input/external clock source input.
OSC2/CLKOUT	15	17	O	—	Oscillator crystal output. Connects to crystal or resonator in Crystal Oscillator mode. In RC mode, OSC2 pin outputs CLKOUT, which has 1/4 the frequency of OSC1 and denotes the instruction cycle rate.
MCLR/VPP	4	4	I/P	ST	Master Clear (Reset) input/programming voltage input. This pin is an Active Low Reset to the device.
RA0/AN0	17	19	I/O	ST	PORTA is a bi-directional I/O port.  Analog comparator input Analog comparator input Analog comparator input or VREF output Analog comparator input /output Can be selected to be the clock input to the Timer0 timer/counter or a comparator output. Output is open drain type.
RA1/AN1	18	20	I/O	ST	
RA2/AN2/VREF	1	1	I/O	ST	
RA3/AN3	2	2	I/O	ST	
RA4/T0CKI	3	3	I/O	ST	
RB0/INT	6	7	I/O	TTL/ST <sup>(1)</sup>	PORTB is a bi-directional I/O port. PORTB can be software programmed for internal weak pull-up on all inputs.  RB0/INT can also be selected as an external interrupt pin.   Interrupt-on-change pin. Interrupt-on-change pin. Interrupt-on-change pin. Serial programming clock. Interrupt-on-change pin. Serial programming data.
RB1	7	8	I/O	TTL	
RB2	8	9	I/O	TTL	
RB3	9	10	I/O	TTL	
RB4	10	11	I/O	TTL	
RB5	11	12	I/O	TTL	
RB6	12	13	I/O	TTL/ST <sup>(2)</sup>	
RB7	13	14	I/O	TTL/ST <sup>(2)</sup>	
Vss	5	5,6	P	—	Ground reference for logic and I/O pins.
VDD	14	15,16	P	—	Positive supply for logic and I/O pins.

Legend:      O = output      I/O = input/output      P = power  
                  — = Not used      I = Input      ST = Schmitt Trigger input  
                  TTL = TTL input

**Note 1:** This buffer is a Schmitt Trigger input when configured as the external interrupt.  
**Note 2:** This buffer is a Schmitt Trigger input when used in Serial Programming mode.

## 7.0 COMPARATOR MODULE

The comparator module contains two analog comparators. The inputs to the comparators are multiplexed with the RA0 through RA3 pins. The On-Chip Voltage Reference (Section 8.0) can also be an input to the comparators.

The CMCON register, shown in Register 7-1, controls the comparator input and output multiplexers. A block diagram of the comparator is shown in Figure 7-1.

### REGISTER 7-1: CMCON REGISTER (ADDRESS 1Fh)

R-0	R-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0
C2OUT	C1OUT	—	—	CIS	CM2	CM1	CM0
bit 7							bit 0

bit 7 **C2OUT**: Comparator 2 output

1 = C2 VIN+ > C2 VIN-

0 = C2 VIN+ < C2 VIN-

bit 6 **C1OUT**: Comparator 1 output

1 = C1 VIN+ > C1 VIN-

0 = C1 VIN+ < C1 VIN-

bit 5-4 **Unimplemented**: Read as '0'

bit 3 **CIS**: Comparator Input Switch

When CM<2:0> = 001:

1 = C1 VIN- connects to RA3

0 = C1 VIN- connects to RA0

When CM<2:0> = 010:

1 = C1 VIN- connects to RA3

C2 VIN- connects to RA2

0 = C1 VIN- connects to RA0

C2 VIN- connects to RA1

bit 2-0 **CM<2:0>**: Comparator mode.

#### Legend:

R = Readable bit

W = Writable bit

U = Unimplemented bit, read as '0'

- n = Value at POR

'1' = Bit is set

'0' = Bit is cleared

x = Bit is unknown

## 9.2 Oscillator Configurations

### 9.2.1 OSCILLATOR TYPES

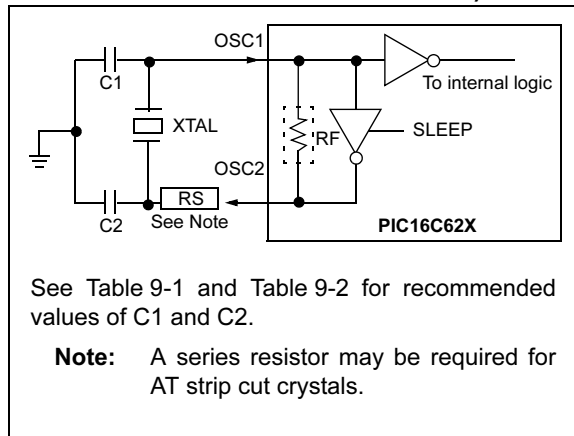
The PIC16C62X devices can be operated in four different oscillator options. The user can program two configuration bits (FOSC1 and FOSC0) to select one of these four modes:

- LP Low Power Crystal
- XT Crystal/Resonator
- HS High Speed Crystal/Resonator
- RC Resistor/Capacitor

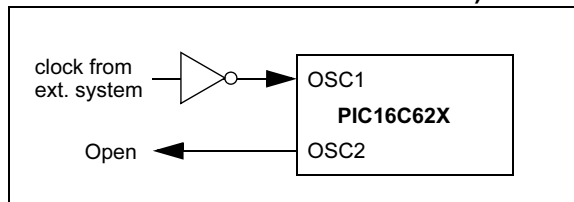
### 9.2.2 CRYSTAL OSCILLATOR / CERAMIC RESONATORS

In XT, LP or HS modes, a crystal or ceramic resonator is connected to the OSC1 and OSC2 pins to establish oscillation (Figure 9-1). The PIC16C62X oscillator design requires the use of a parallel cut crystal. Use of a series cut crystal may give a frequency out of the crystal manufacturers specifications. When in XT, LP or HS modes, the device can have an external clock source to drive the OSC1 pin (Figure 9-2).

**FIGURE 9-1: CRYSTAL OPERATION (OR CERAMIC RESONATOR) (HS, XT OR LP OSC CONFIGURATION)**



**FIGURE 9-2: EXTERNAL CLOCK INPUT OPERATION (HS, XT OR LP OSC CONFIGURATION)**



**TABLE 9-1: CAPACITOR SELECTION FOR CERAMIC RESONATORS**

Ranges Characterized:			
Mode	Freq	OSC1(C1)	OSC2(C2)
XT	455 kHz	22 - 100 pF	22 - 100 pF
	2.0 MHz	15 - 68 pF	15 - 68 pF
	4.0 MHz	15 - 68 pF	15 - 68 pF
HS	8.0 MHz	10 - 68 pF	10 - 68 pF
	16.0 MHz	10 - 22 pF	10 - 22 pF

Higher capacitance increases the stability of the oscillator but also increases the start-up time. These values are for design guidance only. Since each resonator has its own characteristics, the user should consult the resonator manufacturer for appropriate values of external components.

**TABLE 9-2: CAPACITOR SELECTION FOR CRYSTAL OSCILLATOR**

Mode	Freq	OSC1(C1)	OSC2(C2)
LP	32 kHz	68 - 100 pF	68 - 100 pF
	200 kHz	15 - 30 pF	15 - 30 pF
XT	100 kHz	68 - 150 pF	150 - 200 pF
	2 MHz	15 - 30 pF	15 - 30 pF
	4 MHz	15 - 30 pF	15 - 30 pF
HS	8 MHz	15 - 30 pF	15 - 30 pF
	10 MHz	15 - 30 pF	15 - 30 pF
	20 MHz	15 - 30 pF	15 - 30 pF

Higher capacitance increases the stability of the oscillator but also increases the start-up time. These values are for design guidance only. Rs may be required in HS mode as well as XT mode to avoid overdriving crystals with low drive level specification. Since each crystal has its own characteristics, the user should consult the crystal manufacturer for appropriate values of external components.

# PIC16C62X

## 9.4 Power-on Reset (POR), Power-up Timer (PWRT), Oscillator Start-up Timer (OST) and Brown-out Reset (BOR)

### 9.4.1 POWER-ON RESET (POR)

The on-chip POR circuit holds the chip in RESET until VDD has reached a high enough level for proper operation. To take advantage of the POR, just tie the MCLR pin through a resistor to VDD. This will eliminate external RC components usually needed to create Power-on Reset. A maximum rise time for VDD is required. See Electrical Specifications for details.

The POR circuit does not produce an internal RESET when VDD declines.

When the device starts normal operation (exits the RESET condition), device operating parameters (voltage, frequency, temperature, etc.) must be met to ensure operation. If these conditions are not met, the device must be held in RESET until the operating conditions are met.

For additional information, refer to Application Note AN607, "Power-up Trouble Shooting".

### 9.4.2 POWER-UP TIMER (PWRT)

The Power-up Timer provides a fixed 72 ms (nominal) time-out on power-up only, from POR or Brown-out Reset. The Power-up Timer operates on an internal RC oscillator. The chip is kept in RESET as long as PWRT is active. The PWRT delay allows the VDD to rise to an acceptable level. A configuration bit, **PWRT**, can disable (if set) or enable (if cleared or programmed) the Power-up Timer. The Power-up Timer should always be enabled when Brown-out Reset is enabled.

The Power-up Time delay will vary from chip-to-chip and due to VDD, temperature and process variation. See DC parameters for details.

### 9.4.3 OSCILLATOR START-UP TIMER (OST)

The Oscillator Start-Up Timer (OST) provides a 1024 oscillator cycle (from OSC1 input) delay after the PWRT delay is over. This ensures that the crystal oscillator or resonator has started and stabilized.

The OST time-out is invoked only for XT, LP and HS modes and only on Power-on Reset or wake-up from SLEEP.

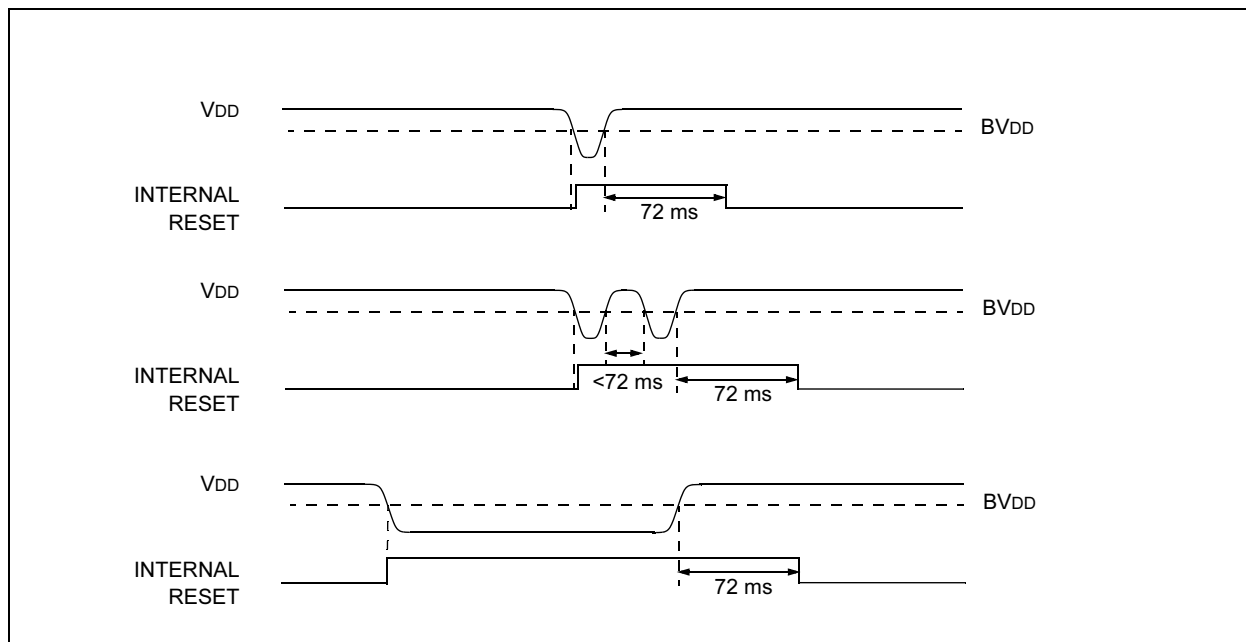
### 9.4.4 BROWN-OUT RESET (BOR)

The PIC16C62X members have on-chip Brown-out Reset circuitry. A configuration bit, **BODEN**, can disable (if clear/programmed) or enable (if set) the Brown-out Reset circuitry. If VDD falls below 4.0V refer to VBOR parameter D005 (VBOR) for greater than parameter (TBOR) in Table 12-5. The brown-out situation will RESET the chip. A RESET won't occur if VDD falls below 4.0V for less than parameter (TBOR).

On any RESET (Power-on, Brown-out, Watchdog, etc.) the chip will remain in RESET until VDD rises above BVDD. The Power-up Timer will now be invoked and will keep the chip in RESET an additional 72 ms.

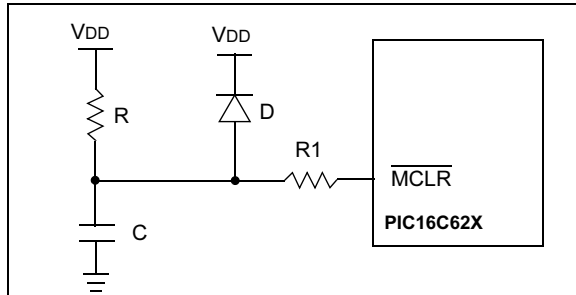
If VDD drops below BVDD while the Power-up Timer is running, the chip will go back into a Brown-out Reset and the Power-up Timer will be re-initialized. Once VDD rises above BVDD, the Power-Up Timer will execute a 72 ms RESET. The Power-up Timer should always be enabled when Brown-out Reset is enabled. Figure 9-7 shows typical Brown-out situations.

**FIGURE 9-7: BROWN-OUT SITUATIONS**



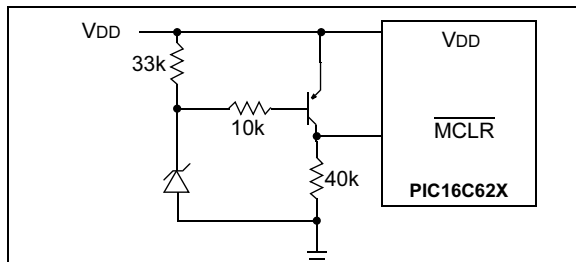
# PIC16C62X

**FIGURE 9-11: EXTERNAL POWER-ON RESET CIRCUIT (FOR SLOW V<sub>DD</sub> POWER-UP)**



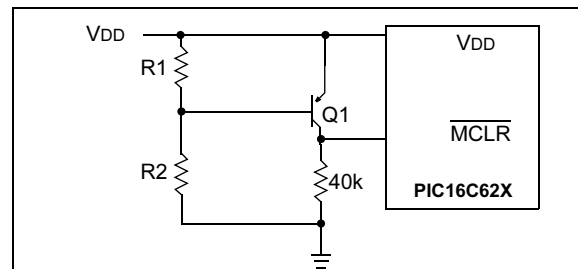
- Note 1:** External Power-on Reset circuit is required only if V<sub>DD</sub> power-up slope is too slow. The diode D helps discharge the capacitor quickly when V<sub>DD</sub> powers down.
- 2:** < 40 kΩ is recommended to make sure that voltage drop across R does not violate the device's electrical specification.
- 3:** R1 = 100Ω to 1 kΩ will limit any current flowing into MCLR from external capacitor C in the event of MCLR/V<sub>PP</sub> pin breakdown due to Electrostatic Discharge (ESD) or Electrical Over-stress (EOS).

**FIGURE 9-12: EXTERNAL BROWN-OUT PROTECTION CIRCUIT 1**



- Note 1:** This circuit will activate RESET when V<sub>DD</sub> goes below (V<sub>Z</sub> + 0.7V) where V<sub>Z</sub> = Zener voltage.
- 2:** Internal Brown-out Reset circuitry should be disabled when using this circuit.

**FIGURE 9-13: EXTERNAL BROWN-OUT PROTECTION CIRCUIT 2**

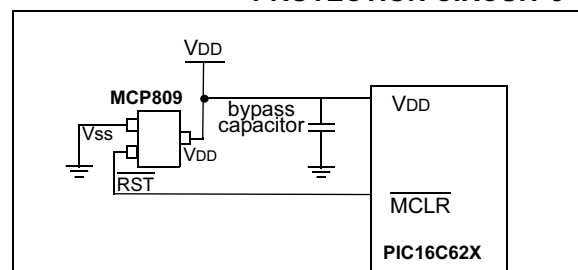


- Note 1:** This brown-out circuit is less expensive, albeit less accurate. Transistor Q1 turns off when V<sub>DD</sub> is below a certain level such that:

$$V_{DD} \times \frac{R1}{R1 + R2} = 0.7V$$

- 2:** Internal Brown-out Reset should be disabled when using this circuit.
- 3:** Resistors should be adjusted for the characteristics of the transistor.

**FIGURE 9-14: EXTERNAL BROWN-OUT PROTECTION CIRCUIT 3**



This brown-out protection circuit employs Microchip Technology's MCP809 microcontroller supervisor. The MCP8XX and MCP1XX families of supervisors provide push-pull and open collector outputs with both high and low active RESET pins. There are 7 different trip point selections to accommodate 5V and 3V systems.



## RLF Rotate Left f through Carry

**Syntax:** [ *label* ] RLF f,d

**Operands:**  $0 \leq f \leq 127$   
 $d \in [0,1]$

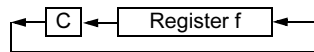
**Operation:** See description below

**Status Affected:** C

**Encoding:**

00	1101	dfff	ffff
----	------	------	------

**Description:** The contents of register 'f' are rotated one bit to the left through the Carry Flag. If 'd' is 0, the result is placed in the W register. If 'd' is 1, the result is stored back in register 'f'.



**Words:** 1

**Cycles:** 1

**Example** RLF REG1,0

**Before Instruction**

REG1 = 1110 0110  
 C = 0

**After Instruction**

REG1 = 1110 0110  
 W = 1100 1100  
 C = 1

## RRF Rotate Right f through Carry

**Syntax:** [ *label* ] RRF f,d

**Operands:**  $0 \leq f \leq 127$   
 $d \in [0,1]$

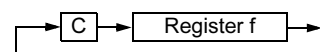
**Operation:** See description below

**Status Affected:** C

**Encoding:**

00	1100	dfff	ffff
----	------	------	------

**Description:** The contents of register 'f' are rotated one bit to the right through the Carry Flag. If 'd' is 0, the result is placed in the W register. If 'd' is 1, the result is placed back in register 'f'.



**Words:** 1

**Cycles:** 1

**Example** RRF REG1,0

**Before Instruction**

REG1 = 1110 0110  
 C = 0

**After Instruction**

REG1 = 1110 0110  
 W = 0111 0011  
 C = 0

## SLEEP

**Syntax:** [ *label* ] SLEEP ]

**Operands:** None

**Operation:** 00h → WDT,  
 0 → WDT prescaler,  
 1 →  $\overline{TO}$ ,  
 0 → PD

**Status Affected:**  $\overline{TO}$ , PD

**Encoding:**

00	0000	0110	0011
----	------	------	------

**Description:** The power-down STATUS bit, PD is cleared. Time-out STATUS bit,  $\overline{TO}$  is set. Watch-dog Timer and its prescaler are cleared.

The processor is put into SLEEP mode with the oscillator stopped. See Section 9.8 for more details.

**Words:** 1

**Cycles:** 1

**Example:** SLEEP

SWAPF		Swap Nibbles in f							
Syntax:	[ <i>label</i> ] SWAPF f,d								
Operands:	$0 \leq f \leq 127$ $d \in [0,1]$								
Operation:	$(f<3:0>) \rightarrow (dest<7:4>),$ $(f<7:4>) \rightarrow (dest<3:0>)$								
Status Affected:	None								
Encoding:	<table><tr><td>00</td><td>1110</td><td>dfff</td><td>ffff</td></tr></table>					00	1110	dfff	ffff
00	1110	dfff	ffff						
Description:	The upper and lower nibbles of register 'f' are exchanged. If 'd' is 0, the result is placed in W register. If 'd' is 1, the result is placed in register 'f'.								
Words:	1								
Cycles:	1								
Example	SWAPF REG, 0								
	Before Instruction								
	REG1 = 0xA5								
	After Instruction								
	REG1 = 0xA5								
	W = 0x5A								

TRIS	Load TRIS Register				
Syntax:	[ <i>label</i> ] TRIS f				
Operands:	$5 \leq f \leq 7$				
Operation:	(W) → TRIS register f;				
Status Affected:	None				
Encoding:	<table><tr><td>00</td><td>0000</td><td>0110</td><td>0fff</td></tr></table>	00	0000	0110	0fff
00	0000	0110	0fff		
Description:	The instruction is supported for code compatibility with the PIC16C5X products. Since TRIS registers are readable and writable, the user can directly address them.				
Words:	1				
Cycles:	1				
Example	<div><b>To maintain upward compatibility with future PICmicro<sup>®</sup> products, do not use this instruction.</b></div>				

XORLW		Exclusive OR Literal with W			
Syntax:	[ <i>label</i> XORLW   k 				

XORWF		Exclusive OR W with f							
Syntax:	[ <i>label</i> ] XORWF f,d								
Operands:	$0 \leq f \leq 127$ $d \in [0,1]$								
Operation:	(W) .XOR. (f) $\rightarrow$ (dest)								
Status Affected:	Z								
Encoding:	<table border="1"><tr><td>00</td><td>0110</td><td>dfff</td><td>ffff</td></tr></table>					00	0110	dfff	ffff
00	0110	dfff	ffff						
Description:	Exclusive OR the contents of the W register with register 'f'. If 'd' is 0, the result is stored in the W register. If 'd' is 1, the result is stored back in register 'f'.								
Words:	1								
Cycles:	1								
Example	XORWF REG 1								
	Before Instruction								
	REG	=	0xAF						
	W	=	0xB5						
	After Instruction								
	REG	=	0x1A						
	W	=	0xB5						

# PIC16C62X

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NOTES:

## 11.14 PICDEM 1 PICmicro Demonstration Board

The PICDEM 1 demonstration board demonstrates the capabilities of the PIC16C5X (PIC16C54 to PIC16C58A), PIC16C61, PIC16C62X, PIC16C71, PIC16C8X, PIC17C42, PIC17C43 and PIC17C44. All necessary hardware and software is included to run basic demo programs. The sample microcontrollers provided with the PICDEM 1 demonstration board can be programmed with a PRO MATE II device programmer, or a PICSTART Plus development programmer. The PICDEM 1 demonstration board can be connected to the MPLAB ICE in-circuit emulator for testing. A prototype area extends the circuitry for additional application components. Features include an RS-232 interface, a potentiometer for simulated analog input, push button switches and eight LEDs.

## 11.15 PICDEM.net Internet/Ethernet Demonstration Board

The PICDEM.net demonstration board is an Internet/Ethernet demonstration board using the PIC18F452 microcontroller and TCP/IP firmware. The board supports any 40-pin DIP device that conforms to the standard pinout used by the PIC16F877 or PIC18C452. This kit features a user friendly TCP/IP stack, web server with HTML, a 24L256 Serial EEPROM for Xmodem download to web pages into Serial EEPROM, ICSP/MPLAB ICD 2 interface connector, an Ethernet interface, RS-232 interface, and a 16 x 2 LCD display. Also included is the book and CD-ROM *"TCP/IP Lean, Web Servers for Embedded Systems,"* by Jeremy Bentham

## 11.16 PICDEM 2 Plus Demonstration Board

The PICDEM 2 Plus demonstration board supports many 18-, 28-, and 40-pin microcontrollers, including PIC16F87X and PIC18FXX2 devices. All the necessary hardware and software is included to run the demonstration programs. The sample microcontrollers provided with the PICDEM 2 demonstration board can be programmed with a PRO MATE II device programmer, PICSTART Plus development programmer, or MPLAB ICD 2 with a Universal Programmer Adapter. The MPLAB ICD 2 and MPLAB ICE in-circuit emulators may also be used with the PICDEM 2 demonstration board to test firmware. A prototype area extends the circuitry for additional application components. Some of the features include an RS-232 interface, a 2 x 16 LCD display, a piezo speaker, an on-board temperature sensor, four LEDs, and sample PIC18F452 and PIC16F877 FLASH microcontrollers.

## 11.17 PICDEM 3 PIC16C92X Demonstration Board

The PICDEM 3 demonstration board supports the PIC16C923 and PIC16C924 in the PLCC package. All the necessary hardware and software is included to run the demonstration programs.

## 11.18 PICDEM 4 8/14/18-Pin Demonstration Board

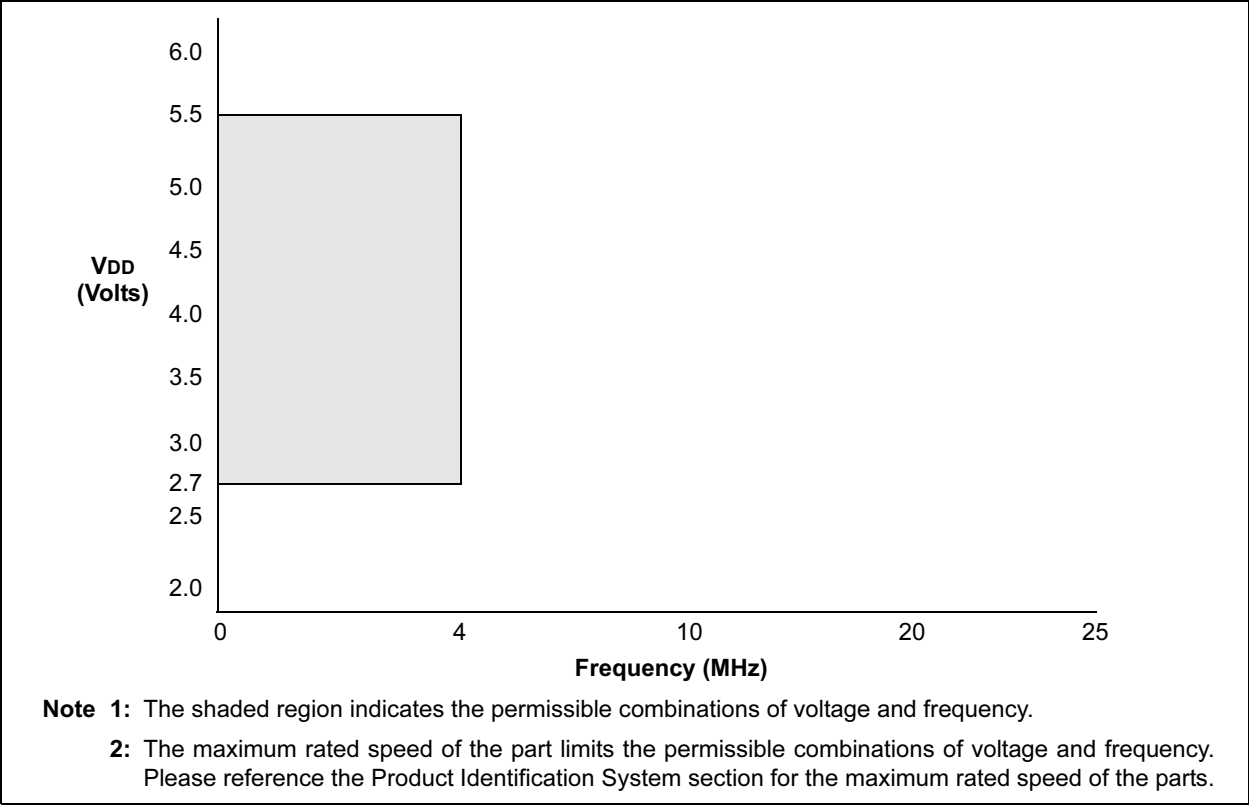
The PICDEM 4 can be used to demonstrate the capabilities of the 8-, 14-, and 18-pin PIC16XXXX and PIC18XXXX MCUs, including the PIC16F818/819, PIC16F87/88, PIC16F62XA and the PIC18F1320 family of microcontrollers. PICDEM 4 is intended to showcase the many features of these low pin count parts, including LIN and Motor Control using ECCP. Special provisions are made for low power operation with the supercapacitor circuit, and jumpers allow on-board hardware to be disabled to eliminate current draw in this mode. Included on the demo board are provisions for Crystal, RC or Canned Oscillator modes, a five volt regulator for use with a nine volt wall adapter or battery, DB-9 RS-232 interface, ICD connector for programming via ICSP and development with MPLAB ICD 2, 2x16 liquid crystal display, PCB footprints for H-Bridge motor driver, LIN transceiver and EEPROM. Also included are: header for expansion, eight LEDs, four potentiometers, three push buttons and a prototyping area. Included with the kit is a PIC16F627A and a PIC18F1320. Tutorial firmware is included along with the User's Guide.

## 11.19 PICDEM 17 Demonstration Board

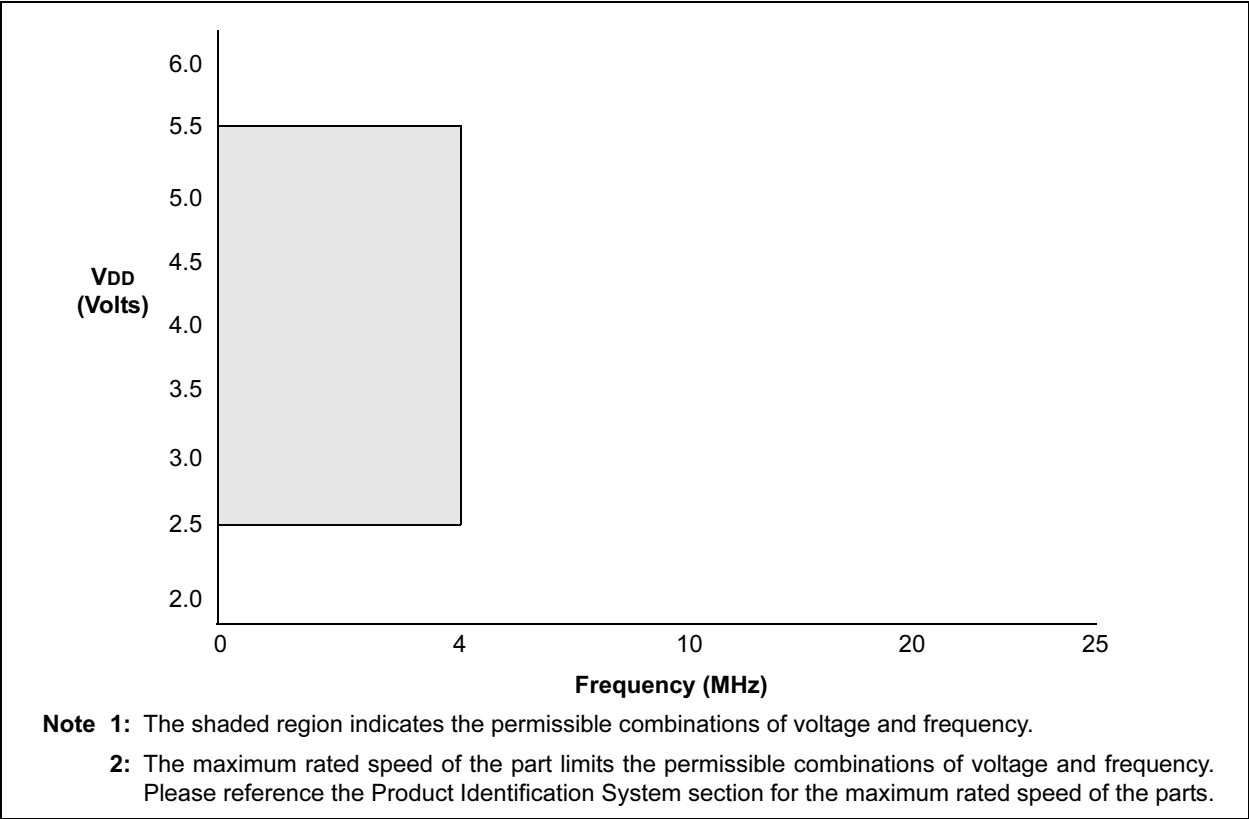
The PICDEM 17 demonstration board is an evaluation board that demonstrates the capabilities of several Microchip microcontrollers, including PIC17C752, PIC17C756A, PIC17C762 and PIC17C766. A programmed sample is included. The PRO MATE II device programmer, or the PICSTART Plus development programmer, can be used to reprogram the device for user tailored application development. The PICDEM 17 demonstration board supports program download and execution from external on-board FLASH memory. A generous prototype area is available for user hardware expansion.

# PIC16C62X

**FIGURE 12-5: PIC16LC620A/LC621A/LC622A VOLTAGE-FREQUENCY GRAPH,  $-40^{\circ}\text{C} \leq T_A \leq 0^{\circ}\text{C}$**



**FIGURE 12-6: PIC16LC620A/LC621A/LC622A VOLTAGE-FREQUENCY GRAPH,  $0^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$**



# PIC16C62X

## 12.1 DC Characteristics: PIC16C62X-04 (Commercial, Industrial, Extended) PIC16C62X-20 (Commercial, Industrial, Extended) PIC16LC62X-04 (Commercial, Industrial, Extended)

PIC16C62X			Standard Operating Conditions (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for industrial and $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ for commercial and $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ for extended				
PIC16LC62X			Standard Operating Conditions (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for industrial and $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ for commercial and $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ for extended Operating voltage VDD range is the PIC16C62X range.				
Param. No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
D001	VDD	Supply Voltage	3.0	—	6.0	V	See Figures 12-1, 12-2, 12-3, 12-4, and 12-5
D001	VDD	Supply Voltage	2.5	—	6.0	V	See Figures 12-1, 12-2, 12-3, 12-4, and 12-5
D002	VDR	RAM Data Retention Voltage <sup>(1)</sup>	—	1.5*	—	V	Device in SLEEP mode
D002	VDR	RAM Data Retention Voltage <sup>(1)</sup>	—	1.5*	—	V	Device in SLEEP mode
D003	VPOR	VDD start voltage to ensure Power-on Reset	—	VSS	—	V	See section on Power-on Reset for details
D003	VPOR	VDD start voltage to ensure Power-on Reset	—	VSS	—	V	See section on Power-on Reset for details
D004	SVDD	VDD rise rate to ensure Power-on Reset	0.05*	—	—	V/ms	See section on Power-on Reset for details
D004	SVDD	VDD rise rate to ensure Power-on Reset	0.05*	—	—	V/ms	See section on Power-on Reset for details
D005	VBOR	Brown-out Detect Voltage	3.7	4.0	4.3	V	BOREN configuration bit is cleared
D005	VBOR	Brown-out Detect Voltage	3.7	4.0	4.3	V	BOREN configuration bit is cleared
D010	IDD	Supply Current <sup>(2)</sup>	—	1.8	3.3	mA	FOSC = 4 MHz, VDD = 5.5V, WDT disabled, XT mode, (Note 4)*
			—	35	70	μA	FOSC = 32 kHz, VDD = 4.0V, WDT disabled, LP mode
			—	9.0	20	mA	FOSC = 20 MHz, VDD = 5.5V, WDT disabled, HS mode
D010	IDD	Supply Current <sup>(2)</sup>	—	1.4	2.5	mA	FOSC = 2.0 MHz, VDD = 3.0V, WDT disabled, XT mode, (Note 4)
			—	26	53	μA	FOSC = 32 kHz, VDD = 3.0V, WDT disabled, LP mode
D020	IPD	Power-down Current <sup>(3)</sup>	—	1.0	2.5	μA	VDD=4.0V, WDT disabled
D020	IPD	Power-down Current <sup>(3)</sup>	—	0.7	2	μA	VDD=3.0V, WDT disabled

\* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

**Note 1:** This is the limit to which VDD can be lowered without losing RAM data.

**2:** The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.

The test conditions for all IDD measurements in Active Operation mode are:

OSC1 = external square wave, from rail to rail; all I/O pins tri-stated, pulled to VDD,

MCLR = VDD; WDT enabled/disabled as specified.

**3:** The power-down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD or VSS.

**4:** For RC osc configuration, current through REXT is not included. The current through the resistor can be estimated by the formula:  $I_r = V_{DD}/2R_{EXT}$  (mA) with REXT in kΩ.

**5:** The Δ current is the additional current consumed when this peripheral is enabled. This current should be added to the base IDD or IPD measurement.

# PIC16C62X

## 12.2 DC Characteristics: PIC16C62XA-04 (Commercial, Industrial, Extended) PIC16C62XA-20 (Commercial, Industrial, Extended) PIC16LC62XA-04 (Commercial, Industrial, Extended (CONT.))

PIC16C62XA			Standard Operating Conditions (unless otherwise stated)				
			Operating temperature -40°C ≤ TA ≤ +85°C for industrial and 0°C ≤ TA ≤ +70°C for commercial and -40°C ≤ TA ≤ +125°C for extended				
PIC16LC62XA			Standard Operating Conditions (unless otherwise stated)				
			Operating temperature -40°C ≤ TA ≤ +85°C for industrial and 0°C ≤ TA ≤ +70°C for commercial and -40°C ≤ TA ≤ +125°C for extended				
Param. No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
D022	ΔI <sub>WDT</sub>	WDT Current <sup>(5)</sup>	—	6.0	10	μA	V <sub>DD</sub> = 4.0V (125°C)
D022A	ΔI <sub>BOR</sub>	Brown-out Reset Current <sup>(5)</sup>	—	75	125	μA	BOD enabled, V <sub>DD</sub> = 5.0V
D023	ΔI <sub>COMP</sub>	Comparator Current for each Comparator <sup>(5)</sup>	—	30	60	μA	V <sub>DD</sub> = 4.0V
D023A	ΔI <sub>VREF</sub>	VREF Current <sup>(5)</sup>	—	80	135	μA	V <sub>DD</sub> = 4.0V
D022	ΔI <sub>WDT</sub>	WDT Current <sup>(5)</sup>	—	6.0	10	μA	V <sub>DD</sub> =4.0V (125°C)
D022A	ΔI <sub>BOR</sub>	Brown-out Reset Current <sup>(5)</sup>	—	75	125	μA	BOD enabled, V <sub>DD</sub> = 5.0V
D023	ΔI <sub>COMP</sub>	Comparator Current for each Comparator <sup>(5)</sup>	—	30	60	μA	V <sub>DD</sub> = 4.0V
D023A	ΔI <sub>VREF</sub>	VREF Current <sup>(5)</sup>	—	80	135	μA	V <sub>DD</sub> = 4.0V
1A	FOSC	LP Oscillator Operating Frequency	0	—	200	kHz	All temperatures
		RC Oscillator Operating Frequency	0	—	4	MHz	All temperatures
		XT Oscillator Operating Frequency	0	—	4	MHz	All temperatures
		HS Oscillator Operating Frequency	0	—	20	MHz	All temperatures
1A	FOSC	LP Oscillator Operating Frequency	0	—	200	kHz	All temperatures
		RC Oscillator Operating Frequency	0	—	4	MHz	All temperatures
		XT Oscillator Operating Frequency	0	—	4	MHz	All temperatures
		HS Oscillator Operating Frequency	0	—	20	MHz	All temperatures

\* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

**Note 1:** This is the limit to which V<sub>DD</sub> can be lowered without losing RAM data.

**2:** The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.

The test conditions for all I<sub>DD</sub> measurements in Active Operation mode are:

OSC1 = external square wave, from rail to rail; all I/O pins tri-stated, pulled to V<sub>DD</sub>,

MCLR = V<sub>DD</sub>; WDT enabled/disabled as specified.

**3:** The power-down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to V<sub>DD</sub> or V<sub>SS</sub>.

**4:** For RC osc configuration, current through R<sub>EXT</sub> is not included. The current through the resistor can be estimated by the formula: I<sub>r</sub> = V<sub>DD</sub>/2R<sub>EXT</sub> (mA) with R<sub>EXT</sub> in kΩ.

**5:** The Δ current is the additional current consumed when this peripheral is enabled. This current should be added to the base I<sub>DD</sub> or I<sub>PD</sub> measurement.

**6:** Commercial temperature range only.

# PIC16C62X

## 12.4 DC Characteristics: PIC16C62X/C62XA/CR62XA (Commercial, Industrial, Extended) PIC16LC62X/LC62XA/LCR62XA (Commercial, Industrial, Extended)

PIC16C62X/C62XA/CR62XA			Standard Operating Conditions (unless otherwise stated)				
			Operating temperature $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for industrial and $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ for commercial and $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ for extended				
PIC16LC62X/LC62XA/LCR62XA			Standard Operating Conditions (unless otherwise stated)				
			Operating temperature $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for industrial and $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ for commercial and $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ for extended				
Param. No.	Sym	Characteristic	Min	Typ†	Max	Units	Conditions
D030 D031 D032 D033	V <sub>IL</sub>	<b>Input Low Voltage</b>					
		I/O ports					
		with TTL buffer	V <sub>SS</sub>	—	0.8V 0.15 V <sub>DD</sub>	V	V <sub>DD</sub> = 4.5V to 5.5V otherwise
		with Schmitt Trigger input	V <sub>SS</sub>	—	0.2 V <sub>DD</sub>	V	(Note 1)
		MCLR, RA4/T0CKI, OSC1 (in RC mode)	V <sub>SS</sub>	—	0.2 V <sub>DD</sub>	V	
D030 D031 D032 D033	V <sub>IL</sub>	OSC1 (in XT and HS)	V <sub>SS</sub>	—	0.3 V <sub>DD</sub>	V	
		OSC1 (in LP)	V <sub>SS</sub>	—	0.6 V <sub>DD</sub> - 1.0	V	
D030 D031 D032 D033	V <sub>IL</sub>	<b>Input Low Voltage</b>					
		I/O ports					
		with TTL buffer	V <sub>SS</sub>	—	0.8V 0.15 V <sub>DD</sub>	V	V <sub>DD</sub> = 4.5V to 5.5V otherwise
		with Schmitt Trigger input	V <sub>SS</sub>	—	0.2 V <sub>DD</sub>	V	(Note 1)
		MCLR, RA4/T0CKI, OSC1 (in RC mode)	V <sub>SS</sub>	—	0.2 V <sub>DD</sub>	V	
D030 D031 D032 D033	V <sub>IL</sub>	OSC1 (in XT and HS)	V <sub>SS</sub>	—	0.3 V <sub>DD</sub>	V	
		OSC1 (in LP)	V <sub>SS</sub>	—	0.6 V <sub>DD</sub> - 1.0	V	
D040 D041 D042 D043 D043A	V <sub>IH</sub>	<b>Input High Voltage</b>					
		I/O ports					
		with TTL buffer	2.0V 0.25 V <sub>DD</sub> + 0.8V	—	V <sub>DD</sub> V <sub>DD</sub>	V	V <sub>DD</sub> = 4.5V to 5.5V otherwise
		with Schmitt Trigger input	0.8 V <sub>DD</sub>	—	V <sub>DD</sub>	V	(Note 1)
		MCLR RA4/T0CKI	0.8 V <sub>DD</sub>	—	V <sub>DD</sub>	V	
D043 D043A	V <sub>IH</sub>	OSC1 (XT, HS and LP)	0.7 V <sub>DD</sub>	—	V <sub>DD</sub>	V	
		OSC1 (in RC mode)	0.9 V <sub>DD</sub>	—	V <sub>DD</sub>	V	(Note 1)

\* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

- Note 1:** In RC oscillator configuration, the OSC1 pin is a Schmitt Trigger input. It is not recommended that the PIC16C62X(A) be driven with external clock in RC mode.
- 2:** The leakage current on the MCLR pin is strongly dependent on applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.
- 3:** Negative current is defined as coming out of the pin.



# PIC16C62X

## 12.5 DC CHARACTERISTICS: PIC16C620A/C621A/C622A-40<sup>(7)</sup> (Commercial) PIC16CR620A-40<sup>(7)</sup> (Commercial)

DC CHARACTERISTICS			Standard Operating Conditions (unless otherwise stated)				
			Operating temperature 0°C ≤ TA ≤ +70°C for commercial				
Param No.	Sym	Characteristic	Min	Typ†	Max	Unit	Conditions
D030	V <sub>IL</sub>	<b>Input Low Voltage</b> I/O ports with TTL buffer	V <sub>SS</sub>	—	0.8V 0.15V <sub>DD</sub>	V	V <sub>DD</sub> = 4.5V to 5.5V, otherwise
D031		with Schmitt Trigger input	V <sub>SS</sub>	—	0.2V <sub>DD</sub>	V	<b>(Note 1)</b>
D032		$\overline{\text{MCLR}}$ , RA4/T0CKI, OSC1 (in RC mode)	V <sub>SS</sub>	—	0.2V <sub>DD</sub>	V	
D033		OSC1 (in XT and HS) OSC1 (in LP)	V <sub>SS</sub> V <sub>SS</sub>	— —	0.3V <sub>DD</sub> 0.6V <sub>DD</sub> - 1.0	V V	
D040	V <sub>IH</sub>	<b>Input High Voltage</b> I/O ports with TTL buffer	2.0V 0.25 V <sub>DD</sub> + 0.8	—	V <sub>DD</sub> V <sub>DD</sub>	V	V <sub>DD</sub> = 4.5V to 5.5V, otherwise
D041		with Schmitt Trigger input	0.8 V <sub>DD</sub>	—	V <sub>DD</sub>	V	<b>(Note 1)</b>
D042		$\overline{\text{MCLR}}$ RA4/T0CKI	0.8 V <sub>DD</sub>	—	V <sub>DD</sub>	V	
D043		OSC1 (XT, HS and LP)	0.7 V <sub>DD</sub>	—	V <sub>DD</sub>	V	
D043A		OSC1 (in RC mode)	0.9 V <sub>DD</sub>	—			
D070	IP <sub>URB</sub>	<b>PORTB Weak Pull-up Current</b>	50	200	400	μA	V <sub>DD</sub> = 5.0V, V <sub>PIN</sub> = V <sub>SS</sub>
D060	I <sub>IL</sub>	<b>Input Leakage Current</b> <sup>(2, 3)</sup> I/O ports (except PORTA)	—	—	±1.0	μA	V <sub>SS</sub> ≤ V <sub>PIN</sub> ≤ V <sub>DD</sub> , pin at hi-impedance
D061		PORTA	—	—	±0.5	μA	V <sub>SS</sub> ≤ V <sub>PIN</sub> ≤ V <sub>DD</sub> , pin at hi-impedance
D063		RA4/T0CKI	—	—	±1.0	μA	V <sub>SS</sub> ≤ V <sub>PIN</sub> ≤ V <sub>DD</sub>
		OSC1, $\overline{\text{MCLR}}$	—	—	±5.0	μA	V <sub>SS</sub> ≤ V <sub>PIN</sub> ≤ V <sub>DD</sub> , XT, HS and LP osc configuration
D080	V <sub>OL</sub>	<b>Output Low Voltage</b> I/O ports	—	—	0.6	V	I <sub>OL</sub> = 8.5 mA, V <sub>DD</sub> = 4.5V, -40° to +85°C
			—	—	0.6	V	I <sub>OL</sub> = 7.0 mA, V <sub>DD</sub> = 4.5V, +125°C
D083		OSC2/CLKOUT (RC only)	—	—	0.6	V	I <sub>OL</sub> = 1.6 mA, V <sub>DD</sub> = 4.5V, -40° to +85°C
			—	—	0.6	V	I <sub>OL</sub> = 1.2 mA, V <sub>DD</sub> = 4.5V, +125°C
D090	V <sub>OH</sub>	<b>Output High Voltage</b> <sup>(3)</sup> I/O ports (except RA4)	V <sub>DD</sub> -0.7 V <sub>DD</sub> -0.7	— —	— —	V V	I <sub>OH</sub> = -3.0 mA, V <sub>DD</sub> = 4.5V, -40° to +85°C I <sub>OH</sub> = -2.5 mA, V <sub>DD</sub> = 4.5V, +125°C
D092		OSC2/CLKOUT (RC only)	V <sub>DD</sub> -0.7 V <sub>DD</sub> -0.7	— —	— —	V V	I <sub>OH</sub> = -1.3 mA, V <sub>DD</sub> = 4.5V, -40° to +85°C I <sub>OH</sub> = -1.0 mA, V <sub>DD</sub> = 4.5V, +125°C
*D150	V <sub>OD</sub>	<b>Open Drain High Voltage</b>			8.5	V	RA4 pin
D100	C <sub>osc2</sub>	<b>Capacitive Loading Specs on Output Pins</b> OSC2 pin			15	pF	In XT, HS and LP modes when external clock used to drive OSC1.
D101	C <sub>io</sub>	All I/O pins/OSC2 (in RC mode)			50	pF	

\* These parameters are characterized but not tested.

† Data in "Typ" column is at 5.0V, 25°C, unless otherwise stated. These parameters are for design guidance only and are not tested.

**Note 1:** This is the limit to which V<sub>DD</sub> can be lowered in SLEEP mode without losing RAM data.

**2:** The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.

The test conditions for all I<sub>DD</sub> measurements in Active Operation mode are:

OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to V<sub>DD</sub>,  $\overline{\text{MCLR}}$  = V<sub>DD</sub>; WDT enabled/disabled as specified.

**3:** The power-down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to V<sub>DD</sub> or V<sub>SS</sub>.

**4:** For RC osc configuration, current through R<sub>EXT</sub> is not included. The current through the resistor can be estimated by the formula  $I_r = V_{DD} / 2R_{EXT}$  (mA) with R<sub>EXT</sub> in kΩ.

**5:** The Δ current is the additional current consumed when this peripheral is enabled. This current should be added to the base I<sub>DD</sub> or I<sub>PD</sub> measurement.

**6:** Commercial temperature range only.

**7:** See Section 12.1 and Section 12.3 for 16C62X and 16CR62X devices for operation between 20 MHz and 40 MHz for valid modified characteristics.

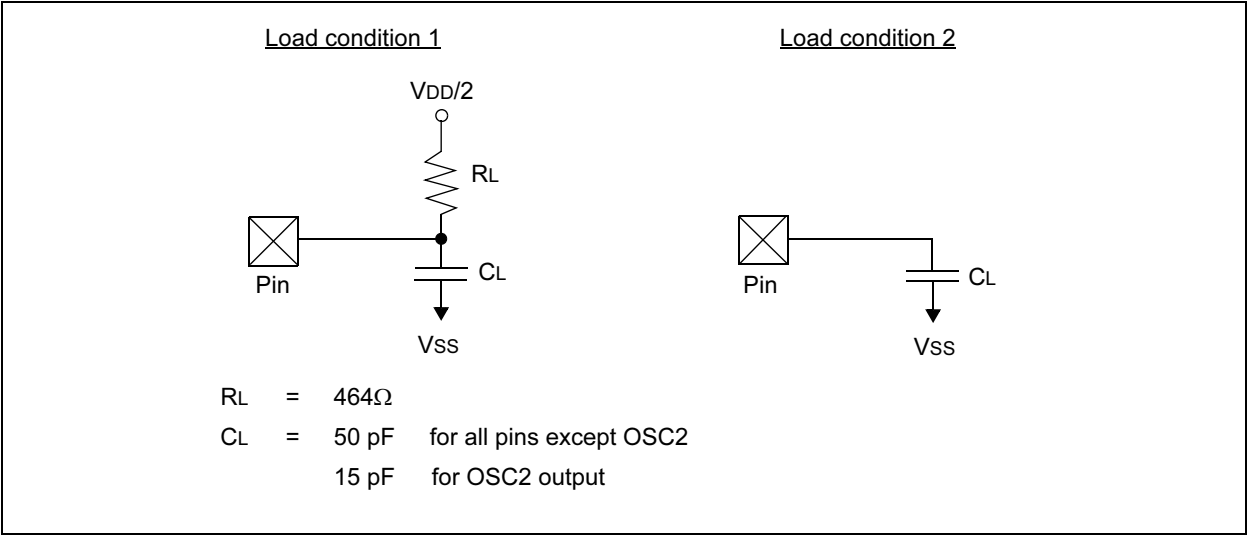
12.8 Timing Parameter Symbolology

The timing parameter symbols have been created with one of the following formats:

- 1. TppS2ppS
- 2. TppS

<b>T</b>			
F	Frequency	T	Time
Lowercase subscripts (pp) and their meanings:			
<b>pp</b>			
ck	CLKOUT	osc	OSC1
io	I/O port	t0	T0CKI
mc	MCLR		
Uppercase letters and their meanings:			
<b>S</b>			
F	Fall	P	Period
H	High	R	Rise
I	Invalid (Hi-impedance)	V	Valid
L	Low	Z	Hi-Impedance

FIGURE 12-11: LOAD CONDITIONS



# PIC16C62X

FIGURE 12-16:     TIMER0 CLOCK TIMING

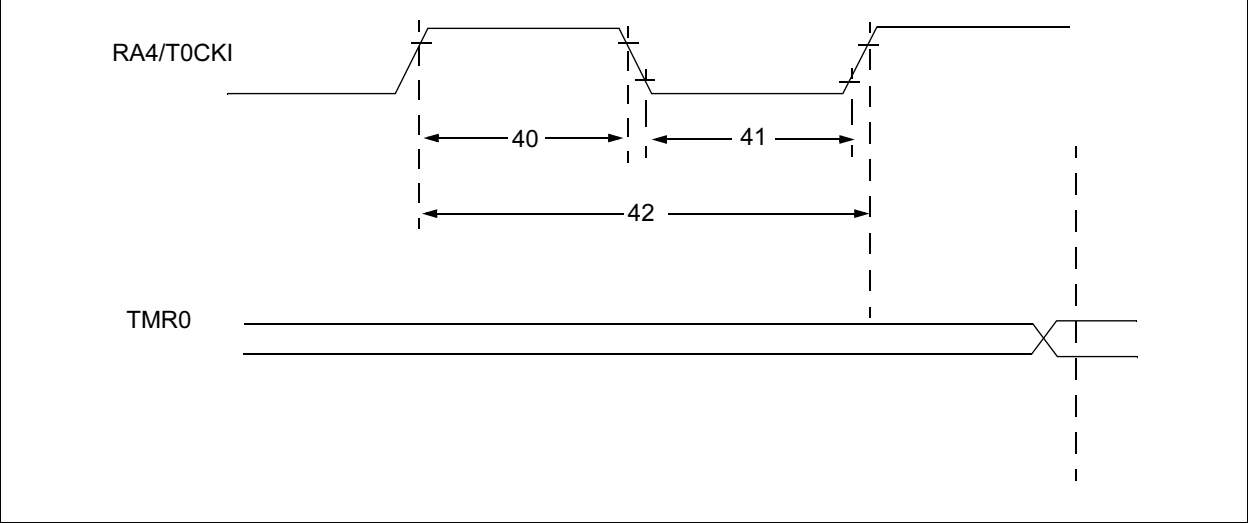


TABLE 12-6:     TIMER0 CLOCK REQUIREMENTS

Parameter No.	Sym	Characteristic		Min	Typ†	Max	Units	Conditions
40	Tt0H	T0CKI High Pulse Width	No Prescaler	$0.5 T_{CY} + 20^*$	—	—	ns	
			With Prescaler	$10^*$	—	—	ns	
41	Tt0L	T0CKI Low Pulse Width	No Prescaler	$0.5 T_{CY} + 20^*$	—	—	ns	
			With Prescaler	$10^*$	—	—	ns	
42	Tt0P	T0CKI Period		$\frac{T_{CY} + 40^*}{N}$	—	—	ns	N = prescale value (1, 2, 4, ..., 256)

\* These parameters are characterized but not tested.

† Data in "Typ" column is at 5.0V, 25°C, unless otherwise stated. These parameters are for design guidance only and are not tested.

# PIC16C62X

FIGURE 13-3: I<sub>DD</sub> VS. V<sub>DD</sub> (XT OSC 4 MHZ)

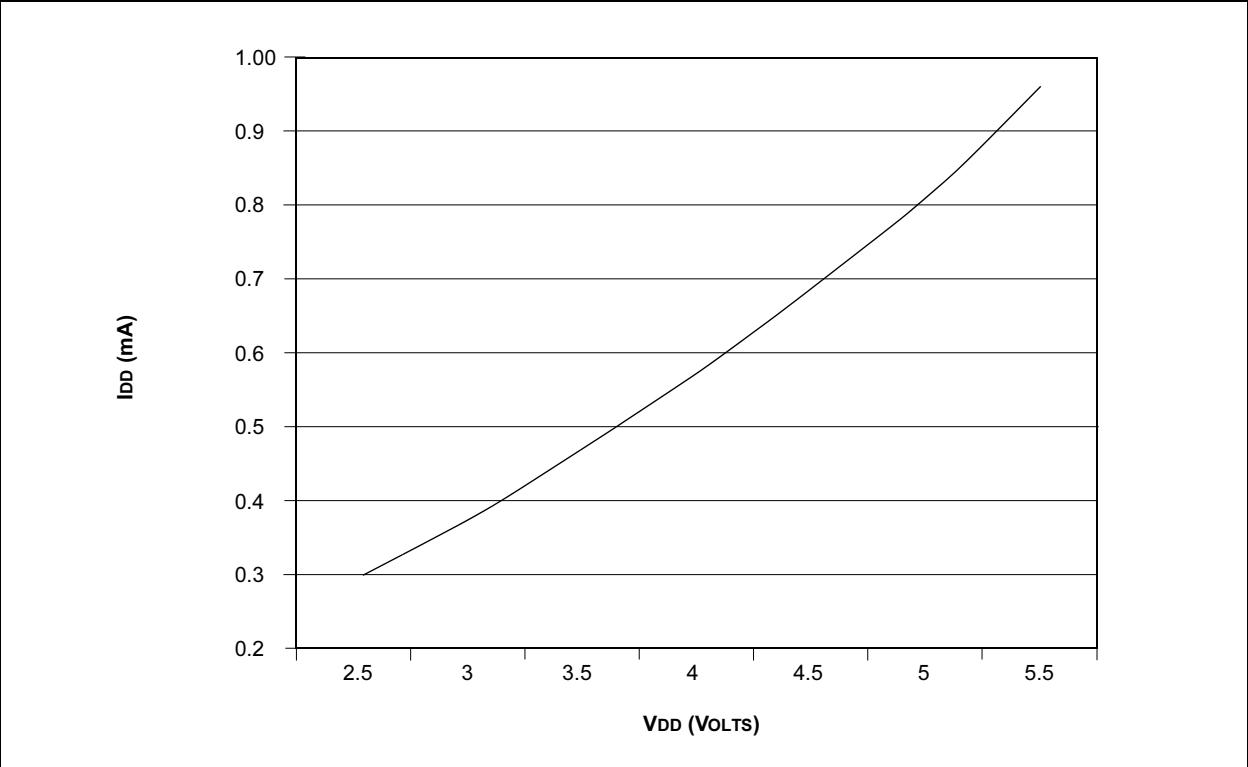
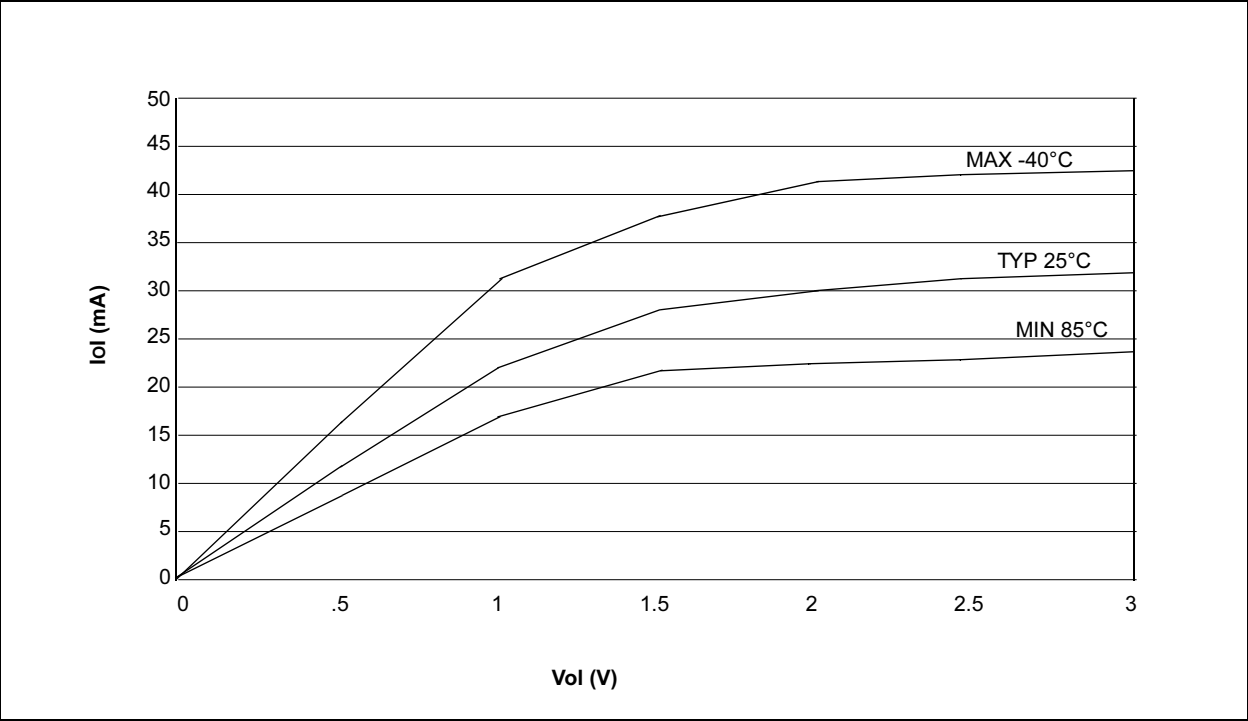


FIGURE 13-4: I<sub>OL</sub> vs. V<sub>OL</sub>, V<sub>DD</sub> = 3.0V



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